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**Kim et al.**

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(54) **HOUSING FOR PACKAGING SEMICONDUCTOR LIGHT EMITTING DEVICE**

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(52) **U.S. Cl.**  
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(58) **Field of Classification Search**

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D9/434, 455-457, 759; D3/304, 295;  
D7/550.1, 553.1-553.8, 581, 586, 587;  
D24/227, 229, 230; 428/131; 229/120;  
220/4.21; 206/733, 528, 486, 485, 427,  
206/461, 828

CPC ..... H01J 5/48; H01J 5/50; H01J 19/54; A61B  
10/0096; A61B 50/20; A61B 50/30; A61C  
2202/00; A61J 1/16; A63B 57/203; B25H  
3/003; B44D 3/125; B65D 73/0092;  
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See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a housing for packaging semi-conductor light emitting device, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a housing for packaging semiconductor light emitting device, showing our new design;

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

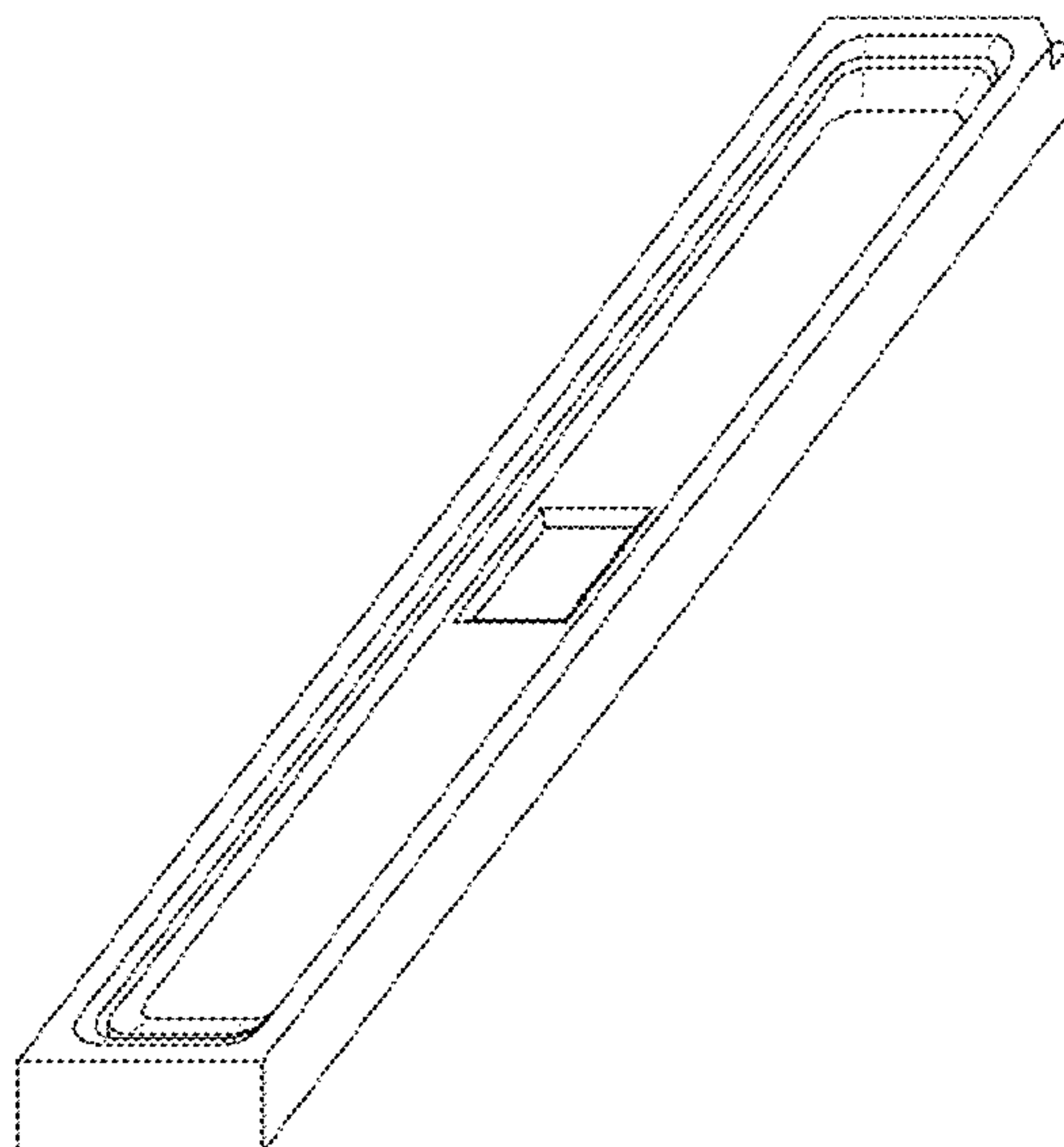
FIG. 4 is a left side view thereof;

FIG. 5 is a right side view thereof;

FIG. 6 is a top view thereof; and,

FIG. 7 is a bottom view thereof.

**1 Claim, 6 Drawing Sheets**



(56)

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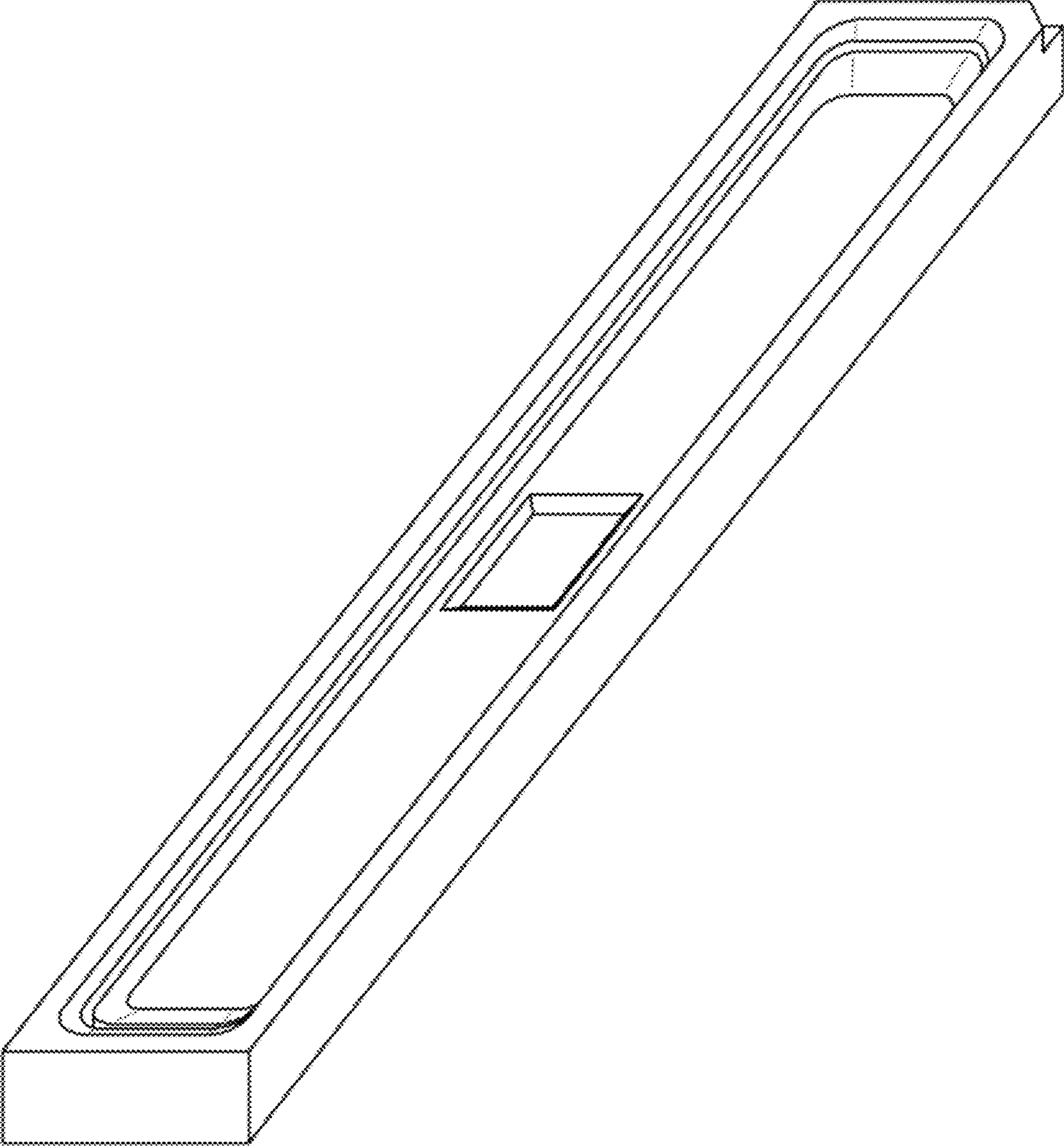


FIG. 1



FIG. 2



FIG. 3



**FIG. 4**



**FIG. 5**

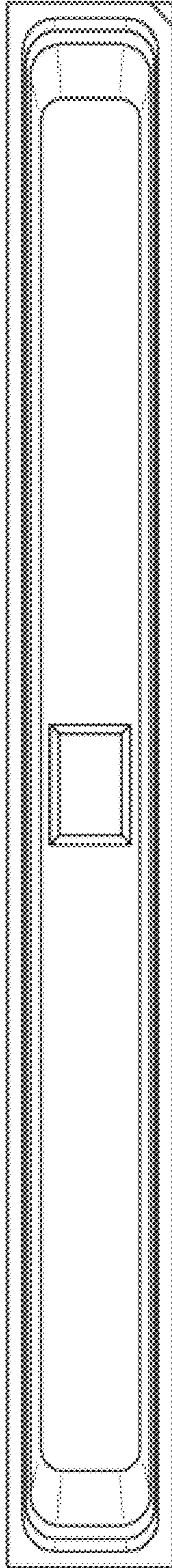


FIG. 6



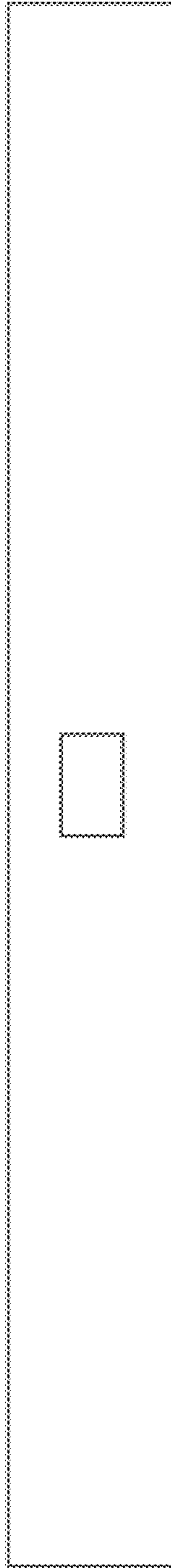


FIG. 7